



Material Content Data Sheet



Sales Product Name		IPI80N06S4L-07		Issued		25. September 2017			
MA#		MA000473028							
Package		PG-TO262-3-1		Weight*		1577.75 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	2.466	0.16	0.16	1563	1563	
leadframe	non noble metal	iron	7439-89-6	0.957	0.06		607		
	inorganic material	phosphorus	7723-14-0	0.287	0.02		182		
	non noble metal	copper	7440-50-8	955.892	60.58	60.66	605855	606645	
wire	non noble metal	aluminium	7429-90-5	55.808	3.54	3.54	35372	35372	
encapsulation	organic material	carbon black	1333-86-4	8.165	0.52		5175		
	plastics	epoxy resin	-	89.813	5.69		56925		
	inorganic material	silicondioxide	60676-86-0	446.342	28.29	34.50	282898	344998	
leadfinish	non noble metal	tin	7440-31-5	15.388	0.98	0.98	9753	9753	
plating	non noble metal	nickel	7440-02-0	0.228	0.01		145		
	inorganic material	phosphorus	7723-14-0	0.001	0.00	0.01	1	145	
solder	noble metal	silver	7440-22-4	0.060	0.00		38		
	non noble metal	tin	7440-31-5	0.048	0.00		30		
	non noble metal	lead	7439-92-1	2.297	0.15	0.15	1456	1524	
*deviation	< 10%					Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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